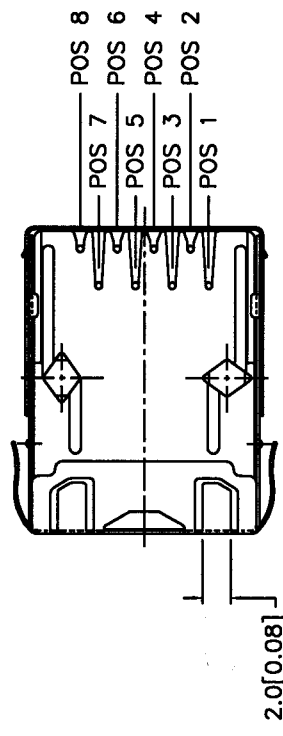
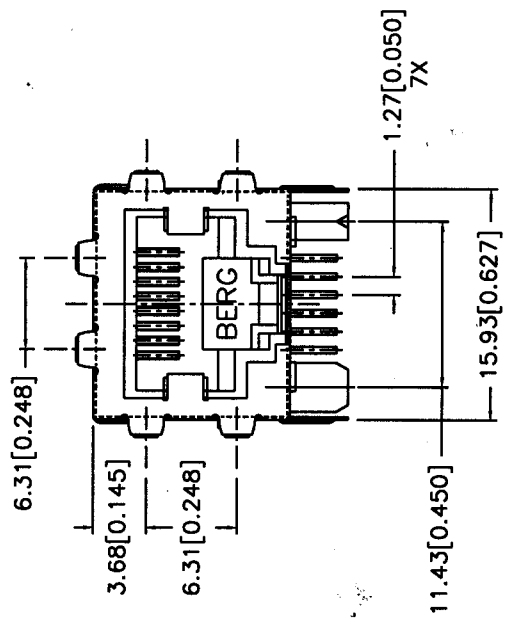
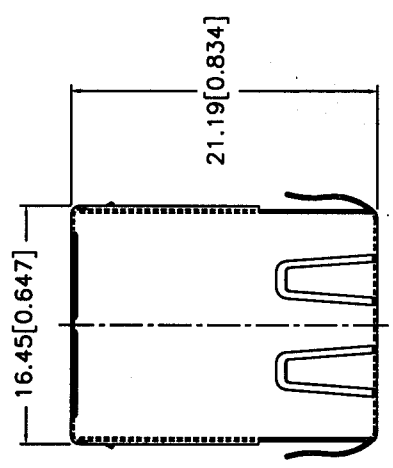


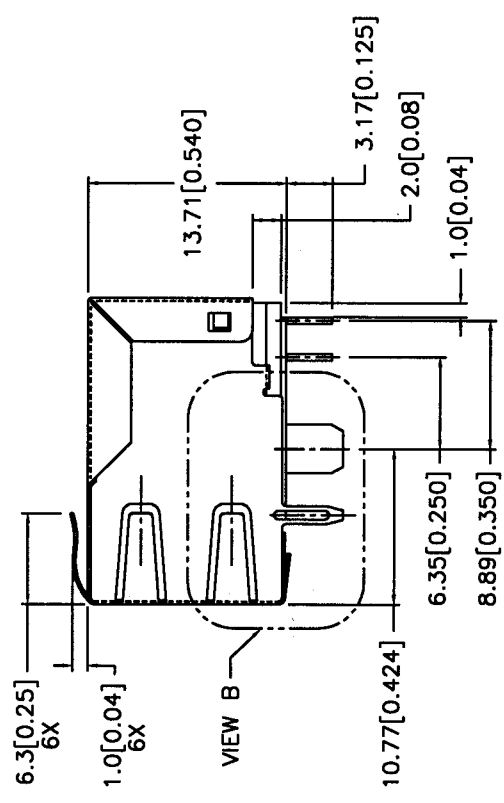


A

B



VIEW A-A



VIEW B

A A

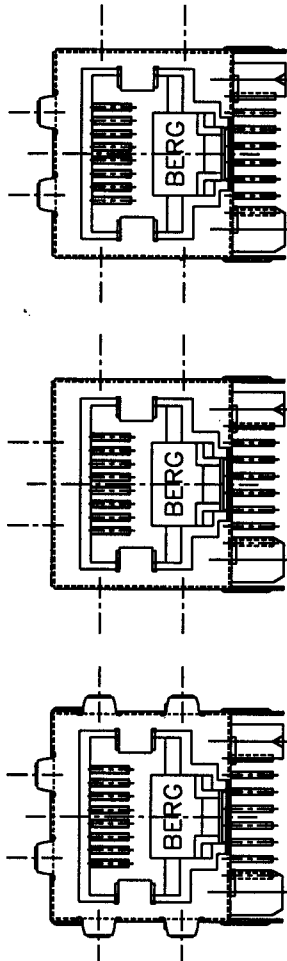
mat'l. code				NOTE 1				tolerances unless otherwise specified				CUSTOMER COPY				FCI			
ltr	ec'n no	dr	date	linear	linear	linear	linear	XX±.3/XX ±.01	XX±.13/XXX ±.005	XXX±.051/XXXX ±.0020	° ±.2°	projection	projection	projection	projection	title	product family	MOD JACK	code
A	V80489	BWN	4/06/98	linear	linear	linear	linear	XX±.3/XX ±.01	XX±.13/XXX ±.005	XXX±.051/XXXX ±.0020	° ±.2°	projection	projection	projection	projection	RJ45 ENCHANCED SHLD SINGLE			
B	V81781	RGD	10/13/98	linear	linear	linear	linear	XX±.3/XX ±.01	XX±.13/XXX ±.005	XXX±.051/XXXX ±.0020	° ±.2°	projection	projection	projection	projection	PORT ASSY DIAMOND PRG			
C	V90568	RGD	2/24/99	angles	angles	angles	angles	XX±.3/XX ±.01	XX±.13/XXX ±.005	XXX±.051/XXXX ±.0020	° ±.2°	projection	projection	projection	projection				
D	V12591	LP	3/19/02	dr	dr	dr	dr	XX±.3/XX ±.01	XX±.13/XXX ±.005	XXX±.051/XXXX ±.0020	° ±.2°	projection	projection	projection	projection				
E	M05-0066	JF	4/16/05	enfr	enfr	enfr	enfr	XX±.3/XX ±.01	XX±.13/XXX ±.005	XXX±.051/XXXX ±.0020	° ±.2°	projection	projection	projection	projection				
				chr	chr	chr	chr	XX±.3/XX ±.01	XX±.13/XXX ±.005	XXX±.051/XXXX ±.0020	° ±.2°	projection	projection	projection	projection				
				appd	appd	appd	appd	XX±.3/XX ±.01	XX±.13/XXX ±.005	XXX±.051/XXXX ±.0020	° ±.2°	projection	projection	projection	projection				
sheet	revision	E	E	E	E	E	E	E	E	E	E	E	E	E	E				
index	sheet	1	2	3	4	5	6	7	8	9	10	11	12	13	14				

PRODUCT NO	DIM A	DIM C	DIM F
74454-001XLF	3.05 [0.120]	N/A	1.02[0.040]
74454-002XLF	4.57 [0.179]	N/A	1.27[0.050]
74454-003XLF	N/A	3.05[0.120]	1.27[0.050]

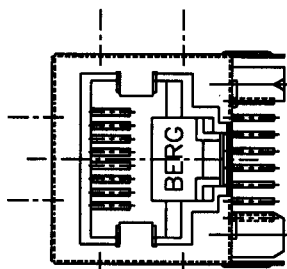
SHIELD OPTION X	DESCRIPTION
1	SPRINGS ON TOP, BOTTOM AND SIDES
2	NO SPRINGS
3	SPRINGS ON TOP AND BOTTOM ONLY
4	SPRINGS ON TOP, BOTTOM AND 1 PER SIDE, STAGGERED
5	SAME AS OPTION 4 EXCEPT OPPOSITE STAGGER

NOTES:

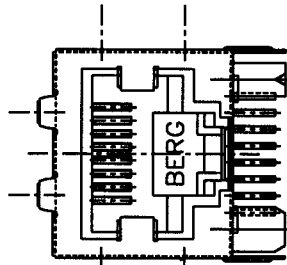
1. RECOMMENDED PCB THICKNESS 1.57 [0.062].
2. HOUSING MATL: HIGH TEMP. THERMOPLASTIC, COLOR BLACK, UL94V-0.
3. CONTACT MATL: COPPER ALLOY
MATING AREA PLATING
4. SHIELDING MATL: TIN PLATED COPPER ALLOY.
5. ALL DIMENSIONS IN MILLIMETERS AND INCHES.
6. DIMENSIONS AND TOLERANCES ARE IN ACCORDANCE WITH ASME Y14.5M 1994.
7. LF SUFFIX AT THE END OF PART NUMBER FOR LEAD FREE OPTION
8. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 15 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.5 mm MINIMUM THICK CIRCUIT BOARD. SEE APPLICATION NOTES/PROCEDURES IF THEY ARE AVAILABLE.
9. THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATION AS DESCRIBED IN GS-22-008.



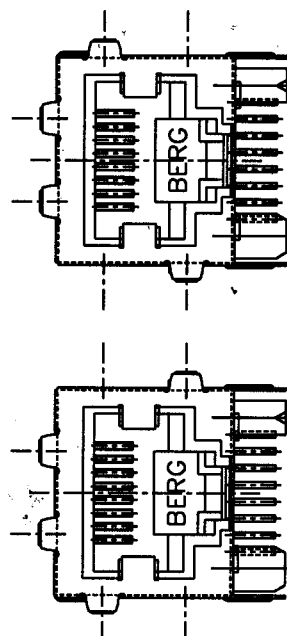
OPTION 1



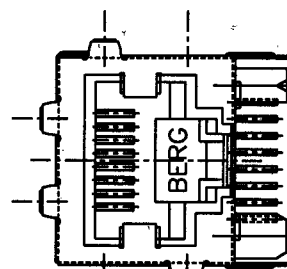
OPTION 2



OPTION 3

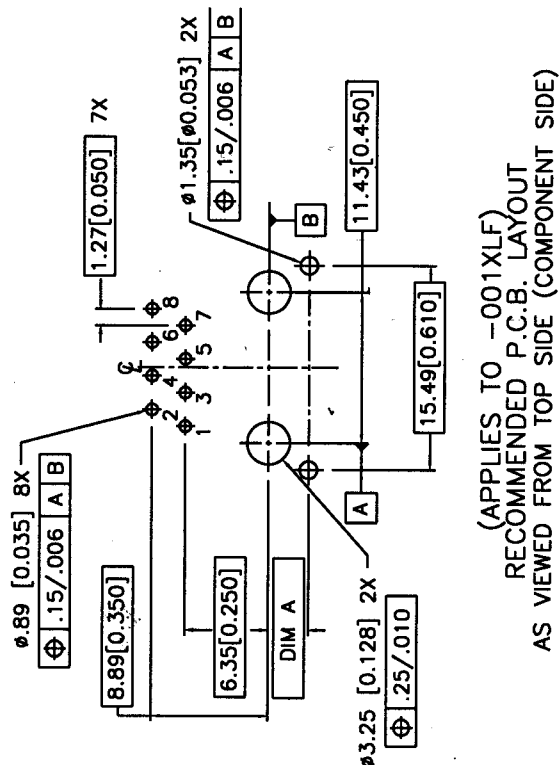
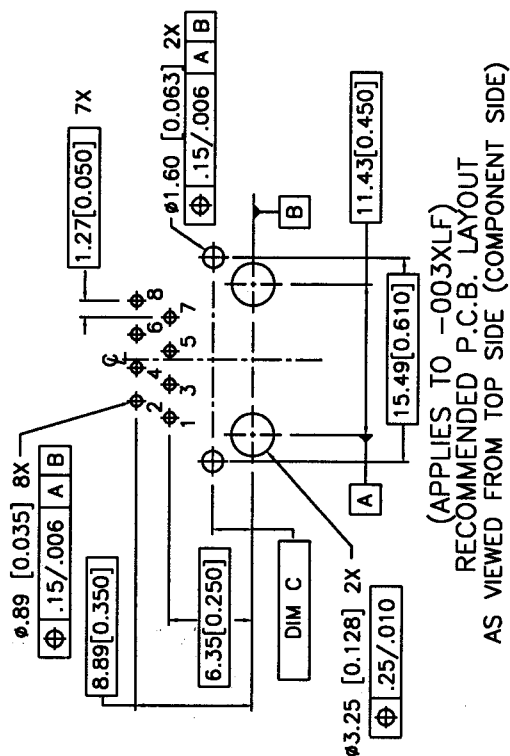


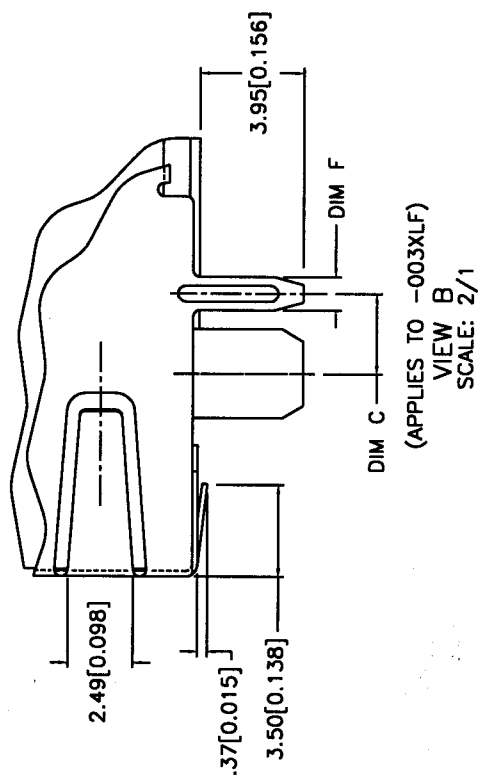
OPTION 4



OPTION 5

mat'l. code		NOTE 1		tolerances unless otherwise specified		CUSTOMER COPY		FCI	
ltr	ecr no	dr	date	linear	.xx ± .3 / .xx ± .01	projection	title	www.fciconnect.com	
E				angles	.xx ± .13 / .xx ± .005	⌀	RJ45 ENHANCED SHLD SINGLE PORT ASSY DIAMOND PRG		
				dr	.xxx ± .051 / .xxx ± .0020	MM/INCH	product family	MOD JACK	code
				enrg	0° ± 2°	scale	size	213	sheet
				chr	R.GRAPE 2/11/98	1:1	A	74454	4 of
				appd	B.MARSHALL 2/11/98				
sheet	revision				B.MARSHALL 2/11/98				
index	sheet								

[illegible]



(APPLIES TO -003XLF)
VIEW B
SCALE: 2/1

(APPLIES TO -001XLF AND -002XLF)
VIEW B
SCALE: 2/1

[illegible]